

August 6, 2008

UNITED STATES PATENT AND TRADEMARK OFFICE

Application No : 10/532,627
Filing Date : April 25, 2005
Applicant : Microbridge Technologies Inc.
Inventor : Leslie M. Landsberger et al.
Title of Invention : METHOD FOR PRODUCING A PACKAGED INTEGRATED
CIRCUIT
Classification : 2822
Examiner : David E. Graybill Tel: (571) 272-1930
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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450
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RESPONSE

Sir:

In response to the Office Action dated May 15, 2008 in connection with the above-identified Application, please consider the following:

Amendments to the claims begin on page 2 of this paper.

Remarks begin on page 8 of this paper.